

NXS0108

Dual supply translating transceiver; open drain;
auto direction sensing

Rev. 1.1 — 31 July 2024

Product data sheet

1. General description

The NXS0108 is an 8-bit, dual supply translating transceiver with auto direction sensing, that enables bidirectional voltage level translation. It features two 8-bit input-output ports (An and Bn), one output enable input (OE) and two supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). $V_{CC(A)}$ can be supplied at any voltage between 1.2 V and 3.6 V and $V_{CC(B)}$ can be supplied at any voltage between 1.65 V and 5.5 V, making the device suitable for translating between any of the voltage nodes (1.2 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins An and OE are referenced to $V_{CC(A)}$ and pins Bn are referenced to $V_{CC(B)}$. A LOW level at pin OE causes the outputs to assume a high-impedance OFF-state. This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range:
 - $V_{CC(A)}$: 1.2 V to 3.6 V and $V_{CC(B)}$: 1.65 V to 5.5 V
- Maximum data rates:
 - Push-pull: 110 Mbps
- I_{OFF} circuitry provides partial Power-down mode operation
- Inputs accept voltages up to 5.5 V
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2500 V for A port
 - HBM: ANSI/ESDA/JEDEC JS-001 class 3B exceeds 15000 V for B port
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1500 V
 - IEC61000-4-2 contact discharge exceeds 8000 V for B port
- Latch-up performance exceeds 100 mA per JESD 78B Class II
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Applications

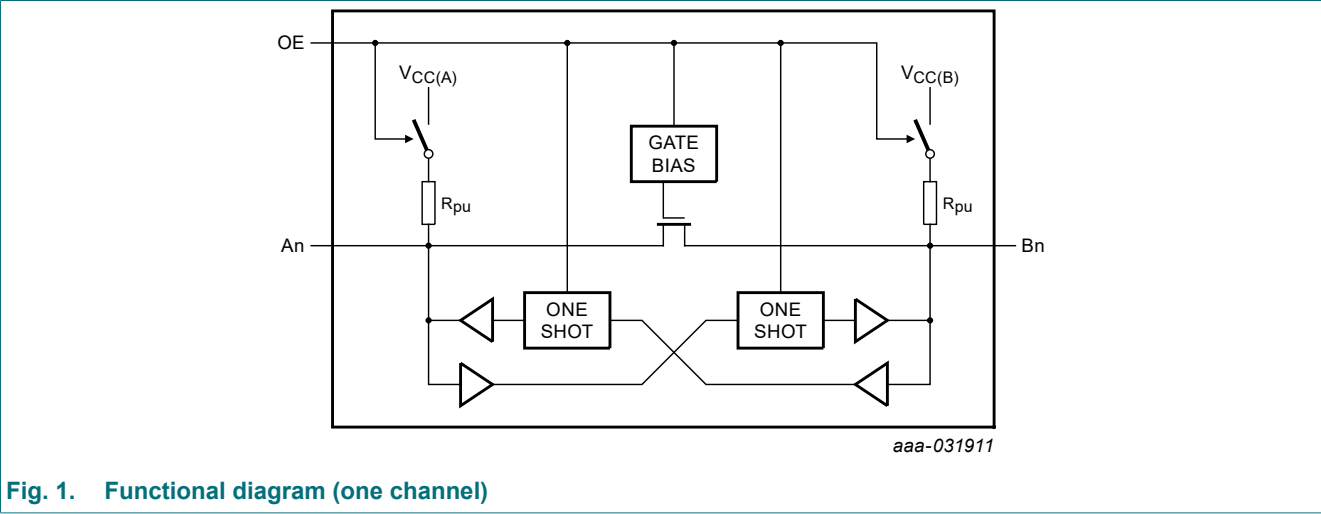
- Desktop PC
- Handset
- Smartphone
- Tablet

4. Ordering information

Table 1. Ordering information

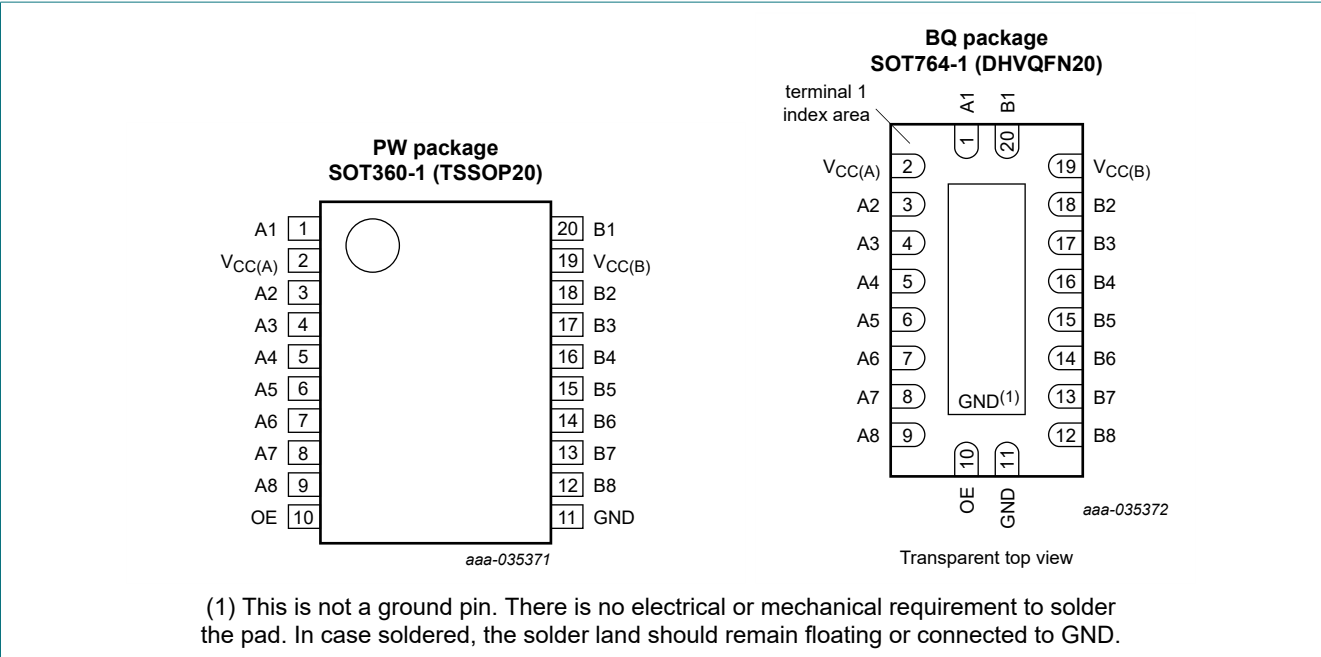
Type number	Package			
	Temperature range	Name	Description	Version
NXS0108PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
NXS0108BQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1

5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
A1, A2, A3, A4, A5, A6, A7, A8	1, 3, 4, 5, 6, 7, 8, 9	data input or output (referenced to $V_{CC(A)}$)
$V_{CC(A)}$	2	supply voltage A
OE	10	output enable input (active HIGH; referenced to $V_{CC(A)}$)
GND	11	ground (0 V)
B1, B2, B3, B4, B5, B6, B7, B8	20, 18, 17, 16, 15, 14, 13, 12	data input or output (referenced to $V_{CC(B)}$)
$V_{CC(B)}$	19	supply voltage B

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Supply voltage		Input	Input/output	
$V_{CC(A)}$ [1]	$V_{CC(B)}$	OE	A	B
1.2 V to 3.6 V	1.65 V to 5.5 V	L	Z	Z
1.2 V to 3.6 V	1.65 V to 5.5 V	H	input or output	output or input
GND	1.65 V to 5.5 V	X	Z	Z
1.2 V to 3.6 V	GND	X	Z	Z

[1] $V_{CC(A)}$ must be less than or equal to $V_{CC(B)}$.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		-0.5	+6.5	V
$V_{CC(B)}$	supply voltage B		-0.5	+6.5	V
V_I	input voltage	OE [1]	-0.5	+6.5	V
		An, Bn; Power-down or 3-state mode [1]	-0.5	+6.5	V
		An, Bn; Active mode [1] [2] [3]	-0.5	$V_{CCI} + 0.5$	V
V_O	output voltage	An, Bn; Power-down or 3-state mode [1]	-0.5	+6.5	V
		An, Bn; Active mode [1] [3] [4]	-0.5	$V_{CCO} + 0.5$	V

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	Min	Max	Unit
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
I _O	output current	V _O = 0 V to V _{CCO} [4]	-	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C [5]	-	500	mW

- [1] The minimum input and minimum output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] V_{CCI} is the supply voltage associated with the input.
[3] V_{CCI} + 0.5 V or V_{CCO} + 0.5 V should not exceed 6.5 V.
[4] V_{CCO} is the supply voltage associated with the output.
[5] For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C.
For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions [1] [2]

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	3.6	V
V _{CC(B)}	supply voltage B		1.65	5.5	V
V _I	input voltage	OE	0	5.5	V
		Power-down or 3-state mode			
		An	0	3.6	V
		Bn	0	5.5	V
		Active mode			
		An, Bn [3]	0	V _{CCI}	V
V _O	output voltage	Power-down or 3-state mode			
		An	0	3.6	V
		Bn	0	5.5	V
		Active mode			
		An, Bn [4]	0	V _{CCO}	V
T _{amb}	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	A or B port; push-pull driving			
		V _{CC(A)} = 1.2 V to 3.6 V; V _{CC(B)} = 1.65 V to 5.5 V	-	10	ns/V
		OE input			
		V _{CC(A)} = 1.2 V to 3.6 V; V _{CC(B)} = 1.65 V to 5.5 V	-	10	ns/V

- [1] The A and B sides of an unused I/O pair must be held in the same state, both at V_{CCI} or both at GND.
[2] V_{CC(A)} must be less than or equal to V_{CC(B)}.
[3] V_{CCI} is the supply voltage associated with the input.
[4] V_{CCO} is the supply voltage associated with the output.

10. Static characteristics

Table 6. Typical static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $T_{amb} = 25\text{ }^{\circ}\text{C}$.^[1]

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OL}	LOW-level output voltage	A port; $V_I \leq 0.15\text{ V}$; $V_{CC(B)} = 1.65\text{ V to }5.5\text{ V}$; $V_{CC(A)} = 1.2\text{ V}$; $I_O = -135\text{ }\mu\text{A}$	-	0.25	-	V
I_I	input leakage current	OE input; $V_I = 0\text{ V to }3.6\text{ V}$; $V_{CC(A)} = 1.2\text{ V to }3.6\text{ V}$; $V_{CC(B)} = 1.65\text{ V to }5.5\text{ V}$	-	-	± 1	μA
I_{OZ}	OFF-state output current	A or B port; $V_O = 0\text{ V or }V_{CCO}$; $V_{CC(A)} = 1.2\text{ V to }3.6\text{ V}$; $V_{CC(B)} = 1.65\text{ V to }5.5\text{ V}$ ^[2]	-	-	± 1	μA
I_{OFF}	power-off leakage current	A port; V_I or $V_O = 0\text{ V to }3.6\text{ V}$; $V_{CC(A)} = 0\text{ V}$; $V_{CC(B)} = 0\text{ V to }5.5\text{ V}$	-	-	± 1	μA
		B port; V_I or $V_O = 0\text{ V to }5.5\text{ V}$; $V_{CC(B)} = 0\text{ V}$; $V_{CC(A)} = 0\text{ V to }3.6\text{ V}$	-	-	± 1	μA
C_I	input capacitance	OE input; $V_{CC(A)} = 3.3\text{ V}$; $V_{CC(B)} = 3.3\text{ V}$	-	2.6	-	pF
$C_{I/O}$	input/output capacitance	A port; $V_{CC(A)} = 3.3\text{ V}$; $V_{CC(B)} = 3.3\text{ V}$				
		enabled	-	9	-	pF
		disabled	-	5.2	-	pF
		B port; $V_{CC(A)} = 3.3\text{ V}$; $V_{CC(B)} = 3.3\text{ V}$				
		enabled	-	10.5	-	pF
		disabled	-	9	-	pF

[1] $V_{CC(A)}$ must be less than or equal to $V_{CC(B)}$.
[2] V_{CCO} is the supply voltage associated with the output.

Table 7. Typical supply current

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $T_{amb} = 25\text{ }^{\circ}\text{C}$.

V _{CC(A)}	V _{CC(B)}								Unit
	1.8 V		2.5 V		3.3 V		5.0 V		
	I _{CC(A)}	I _{CC(B)}	I _{CC(A)}	I _{CC(B)}	I _{CC(A)}	I _{CC(B)}	I _{CC(A)}	I _{CC(B)}	
1.2 V	0.1	0.3	0.1	0.9	0.1	1.9	0.1	5.6	μA
1.5 V	0.1	0.1	0.1	0.7	0.1	1.7	0.1	5	μA
1.8 V	0.1	0.1	0.1	0.5	0.1	1.5	0.1	4.6	μA
2.5 V	-	-	0.1	0.1	0.1	0.8	0.1	3.8	μA
3.3 V	-	-	-	-	0.1	0.1	0.1	2.8	μA

Dual supply translating transceiver; open drain; auto direction sensing

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).[1]

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	A port					
		$V_{CC(A)} = 1.2 \text{ V to } 1.95 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$V_{CC(A)} - 0.2$	-	$V_{CC(A)} - 0.2$	-	V
		$V_{CC(A)} = 1.95 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$V_{CC(A)} - 0.4$	-	$V_{CC(A)} - 0.4$	-	V
		B port					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$V_{CC(B)} - 0.4$	-	$V_{CC(B)} - 0.4$	-	V
		OE input					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$0.65V_{CC(A)}$	-	$0.65V_{CC(A)}$	-	V
V_{IL}	LOW-level input voltage	A or B port					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	-	0.15	-	0.15	V
		OE input					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	-	$0.35V_{CC(A)}$	-	$0.35V_{CC(A)}$	V
V_{OH}	HIGH-level output voltage	A port; $I_O = -20 \mu\text{A}; V_I \geq V_{CC(B)} - 0.4 \text{ V}$					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$0.67V_{CC(A)}$	-	$0.67V_{CC(A)}$	-	V
		B port; $I_O = -20 \mu\text{A}; V_I \geq V_{CC(A)} - 0.2 \text{ V}$					
		$V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	$0.67V_{CC(B)}$	-	$0.67V_{CC(B)}$	-	V
V_{OL}	LOW-level output voltage	A port; $V_I \leq 0.15 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$					
		$V_{CC(A)} = 1.4 \text{ V}; I_O = -180 \mu\text{A}$	-	0.4	-	0.4	V
		$V_{CC(A)} = 1.65 \text{ V}; I_O = -220 \mu\text{A}$	-	0.4	-	0.4	V
		$V_{CC(A)} = 2.3 \text{ V}; I_O = -300 \mu\text{A}$	-	0.4	-	0.4	V
		$V_{CC(A)} = 3.0 \text{ V}; I_O = -400 \mu\text{A}$	-	0.55	-	0.55	V
		B port; $V_I \leq 0.15 \text{ V};$ $V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V}$					
		$V_{CC(B)} = 1.65 \text{ V}; I_O = -220 \mu\text{A}$	-	0.4	-	0.4	V
		$V_{CC(B)} = 2.3 \text{ V}; I_O = -300 \mu\text{A}$	-	0.4	-	0.4	V
		$V_{CC(B)} = 3.0 \text{ V}; I_O = -400 \mu\text{A}$	-	0.55	-	0.55	V
		$V_{CC(B)} = 4.5 \text{ V}; I_O = -620 \mu\text{A}$	-	0.55	-	0.55	V
I_I	input leakage current	OE input; $V_I = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	-	± 2	-	± 12	μA
I_{OZ}	OFF-state output current	A or B port; $V_O = 0 \text{ V or } V_{CCO};$ [2] $V_{CC(A)} = 1.2 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.65 \text{ V to } 5.5 \text{ V}$	-	± 2	-	± 12	μA
I_{OFF}	power-off leakage current	A port; $V_I \text{ or } V_O = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC(A)} = 0 \text{ V}; V_{CC(B)} = 0 \text{ V to } 5.5 \text{ V}$	-	± 2	-	± 12	μA
		B port; $V_I \text{ or } V_O = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 0 \text{ V}; V_{CC(A)} = 0 \text{ V to } 5.5 \text{ V}$	-	± 2	-	± 12	μA

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
I _{CC}	supply current	OE = 0 V or V _{CC(A)} ; An, Bn open					
		I _{CC(A)}					
		V _{CC(A)} = 1.2 V; V _{CC(B)} = 1.65 V to 5.5 V	-5	0.5	-5	1	µA
		V _{CC(A)} = 1.5 V to 3.6 V; V _{CC(B)} = 2.3 V to 5.5 V	-2	1.2	-2	2	µA
		V _{CC(A)} = 3.6 V; V _{CC(B)} = 0 V	-	1.0	-	2	µA
		V _{CC(A)} = 0 V; V _{CC(B)} = 5.5 V	-1	-	-1	-	µA
		I _{CC(B)}					
		V _{CC(A)} = 1.2 V; V _{CC(B)} = 1.65 V to 5.5 V	-	22	-	60	µA
		V _{CC(A)} = 1.5 V to 3.6 V; V _{CC(B)} = 2.3 V to 5.5 V	-	20	-	20	µA
		V _{CC(A)} = 3.6 V; V _{CC(B)} = 0 V	-1	-	-1	-	µA
		V _{CC(A)} = 0 V; V _{CC(B)} = 5.5 V	-	2	-	12	µA
		I _{CC(A)} + I _{CC(B)}					
		V _{CC(A)} = 1.2 ; V _{CC(B)} = 2.3 V to 5.5 V	-	17	-	65	µA
		V _{CC(A)} = 1.5 V to 3.6 V; V _{CC(B)} = 2.3 V to 5.5 V	-	20	-	20	µA

[1] V_{CC(A)} must be less than or equal to V_{CC(B)}.
[2] V_{CCO} is the supply voltage associated with the output.

11. Dynamic characteristics

Table 9. Typical dynamic characteristics
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 2 and Fig. 4.

Symbol	Parameter	Conditions	V _{CC(B)}				Unit
			1.8 V ± 0.15 V	2.5 V ± 0.2 V	3.3 V ± 0.3 V	5.0 V ± 0.5 V	
V _{CC(A)} = 1.2 V; T _{amb} = 25 °C							
t _{PHL}	HIGH to LOW propagation delay	A to B	6.5	5.9	5.7	5.5	ns
t _{PLH}	LOW to HIGH propagation delay	A to B	7.1	6.3	6.2	6.6	ns
t _{PHL}	HIGH to LOW propagation delay	B to A	6.2	5.4	5.1	5	ns
t _{PLH}	LOW to HIGH propagation delay	B to A	5.6	4.1	3.6	3.2	ns
t _{en}	enable time	OE to A; B [1]	200	200	200	200	ns
t _{dis}	disable time	OE to A; no external load [1]	12	12	12	12	ns
		[2]					
		OE to B; no external load [2]	12	12	12	12	ns
		OE to A; see Fig. 3	90	90	90	90	ns
t _{TLH}	LOW to HIGH output transition time	OE to B; see Fig. 3	95	75	100	75	ns
		A port	6.5	5.2	4.8	4.4	ns
t _{THL}	HIGH to LOW output transition time	B port	6.6	4.3	2.1	1.5	ns
		A port	5.8	4.8	4.3	3.8	ns
t _{sk(o)}	output skew time	B port	3.6	2.2	1.8	1.5	ns
		between channels [3]	1	1	1	1	ns
t _W	pulse width	data inputs	20	16.7	16.7	16.7	ns
f _{data}	data rate		50	60	60	60	Mbps

[1] t_{en} is the same as t_{pZL} and t_{pZH}; t_{dis} is the same as t_{pLZ} and t_{pHZ}.
[2] These values are guaranteed by design.
[3] Skew between any two outputs of the same package switching in the same direction.

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Table 10. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 2 and Fig. 4.

Symbol	Parameter	Conditions	V _{CC(B)}								Unit
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} = 1.5 V ± 0.1 V											
t _{PHL}	HIGH to LOW propagation delay	A to B	-	11	-	9.2	-	8.6	-	8.6	ns
t _{PLH}	LOW to HIGH propagation delay	A to B	-	12.6	-	10	-	9.8	-	9.7	ns
t _{PHL}	HIGH to LOW propagation delay	B to A	-	12.7	-	11.1	-	11	-	12	ns
t _{PLH}	LOW to HIGH propagation delay	B to A	-	10.5	-	6.9	-	5.6	-	4.6	ns
t _{en}	enable time	OE to A; B [1]	-	200	-	200	-	200	-	200	ns
t _{dis}	disable time	OE to A; no external load [1]	-	17	-	17	-	17	-	17	ns
		OE to B; no external load [2]	-	18	-	17	-	17	-	17	ns
		OE to A; see Fig. 3	-	120	-	120	-	120	-	125	ns
		OE to B; see Fig. 3	-	170	-	125	-	175	-	125	ns
t _{TLH}	LOW to HIGH output transition time	A port	2.6	13.1	2.8	9.8	2.0	9.0	2.0	8.3	ns
		B port	2.9	11.4	1.9	8.1	0.9	5.3	0.7	3	ns
t _{THL}	HIGH to LOW output transition time	A port	2.1	9.9	1.5	7.7	1.2	6.8	0.8	6.0	ns
		B port	1.5	8.7	1.0	5.5	0.9	3.8	0.8	3.1	ns
t _{sk(o)}	output skew time	between channels [3]	-	1	-	1	-	1.1	-	1	ns
t _W	pulse width	data inputs	20	-	20	-	20	-	20	-	ns
f _{data}	data rate		-	50	-	50	-	50	-	50	Mbps
V _{CC(A)} = 1.8 V ± 0.15 V											
t _{PHL}	HIGH to LOW propagation delay	A to B	-	9.7	-	7.3	-	6.5	-	5.9	ns
t _{PLH}	LOW to HIGH propagation delay	A to B	-	11.3	-	8.4	-	7.4	-	6.5	ns
t _{PHL}	HIGH to LOW propagation delay	B to A	-	9.8	-	8.0	-	7.4	-	7.0	ns
t _{PLH}	LOW to HIGH propagation delay	B to A	-	10.2	-	7.0	-	5.8	-	5.0	ns
t _{en}	enable time	OE to A; B [1]	-	200	-	200	-	200	-	200	ns
t _{dis}	disable time	OE to A; no external load [1]	-	13	-	13	-	13	-	13	ns
		OE to B; no external load [2]	-	16	-	13	-	13	-	13	ns
		OE to A; see Fig. 3	-	140	-	140	-	140	-	145	ns
		OE to B; see Fig. 3	-	165	-	125	-	175	-	125	ns
t _{TLH}	LOW to HIGH output transition time	A port	2.2	11.9	2.0	8.6	1.9	7.8	1.9	7.2	ns
		B port	2.8	12.2	1.8	7.7	1.2	5.3	0.7	2.9	ns
t _{THL}	HIGH to LOW output transition time	A port	1.8	8.8	1.3	6.6	0.9	5.7	0.6	4.9	ns
		B port	1.3	8.3	1.0	5.4	0.9	3.9	0.7	3.0	ns
t _{sk(o)}	output skew time	between channels [3]	-	1	-	1	-	1	-	1	ns
t _W	pulse width	data inputs	22.2	-	16.7	-	16.7	-	16.7	-	ns
f _{data}	data rate		-	45	-	60	-	60	-	60	Mbps

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	V _{CC(B)}								Unit	
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V			
			Min	Max	Min	Max	Min	Max	Min	Max		
V _{CC(A)} = 2.5 V ± 0.2 V												
t _{PHL}	HIGH to LOW propagation delay	A to B	-	-	-	6.2	-	5.3	-	4.7	ns	
t _{PLH}	LOW to HIGH propagation delay	A to B	-	-	-	6.8	-	5.9	-	5.2	ns	
t _{PHL}	HIGH to LOW propagation delay	B to A	-	-	-	5.9	-	4.8	-	4.2	ns	
t _{PLH}	LOW to HIGH propagation delay	B to A	-	-	-	6.2	-	4.6	-	3.6	ns	
t _{en}	enable time	OE to A; B [1]	-	-	-	200	-	200	-	200	ns	
t _{dis}	disable time	OE to A; no external load [1]	-	-	-	9	-	9	-	9	ns	
		OE to B; no external load [2]	-	-	-	11	-	9	-	9	ns	
		OE to A; see Fig. 3	-	-	-	105	-	105	-	105	ns	
		OE to B; see Fig. 3	-	-	-	125	-	175	-	120	ns	
t _{TLH}	LOW to HIGH output transition time	A port	-	-	1.7	7.3	1.7	6.4	1.8	5.8	ns	
		B port	-	-	1.8	7.3	1.3	5.4	0.8	3.3	ns	
t _{THL}	HIGH to LOW output transition time	A port	-	-	1.3	5.7	0.8	4.7	0.6	3.8	ns	
		B port	-	-	1.1	5.4	0.9	4.1	0.7	3.0	ns	
t _{sk(o)}	output skew time	between channels [3]	-	-	-	1	-	1.2	-	1	ns	
t _W	pulse width	data inputs	-	-	14	-	11	-	11	-	ns	
f _{data}	data rate		-	-	-	70	-	90	-	90	Mbps	

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	V _{CC(B)}								Unit	
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V			
			Min	Max	Min	Max	Min	Max	Min	Max		
V _{CC(A)} = 3.3 V ± 0.3 V												
t _{PHL}	HIGH to LOW propagation delay	A to B	-	-	-	-	-	4.9	-	4.2	ns	
t _{PLH}	LOW to HIGH propagation delay	A to B	-	-	-	-	-	5.2	-	4.6	ns	
t _{PHL}	HIGH to LOW propagation delay	B to A	-	-	-	-	-	4.7	-	3.8	ns	
t _{PLH}	LOW to HIGH propagation delay	B to A	-	-	-	-	-	4.7	-	4.3	ns	
t _{en}	enable time	OE to A; B [1]	-	-	-	-	-	200	-	200	ns	
t _{dis}	disable time	OE to A; no external load [1]	-	-	-	-	-	8	-	8	ns	
		OE to B; no external load [2]	-	-	-	-	-	8	-	8	ns	
		OE to A; see Fig. 3	-	-	-	-	-	150	-	150	ns	
		OE to B; see Fig. 3	-	-	-	-	-	170	-	120	ns	
t _{TLH}	LOW to HIGH output transition time	A port	-	-	-	-	1.6	5.7	1.8	5.0	ns	
		B port	-	-	-	-	1.5	5.4	0.9	3.9	ns	
t _{THL}	HIGH to LOW output transition time	A port	-	-	-	-	1.0	4.5	0.6	3.5	ns	
		B port	-	-	-	-	1.0	4.2	0.8	3.1	ns	
t _{sk(o)}	output skew time	between channels [3]	-	-	-	-	-	1	-	1	ns	
t _W	pulse width	data inputs	-	-	-	-	11	-	9	-	ns	
f _{data}	data rate		-	-	-	-	-	90	-	110	Mbps	

[1] t_{en} is the same as t_{PZL} and t_{PZH}; t_{dis} is the same as t_{PLZ} and t_{PHZ}.
[2] These values are guaranteed by design.
[3] Skew between any two outputs of the same package switching in the same direction.

Dual supply translating transceiver; open drain; auto direction sensing

Table 11. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 2 and Fig. 4.

Symbol	Parameter	Conditions	V _{CC(B)}								Unit
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} = 1.5 V ± 0.1 V											
t _{PHL}	HIGH to LOW propagation delay	A to B	-	13.8	-	11.5	-	10.8	-	10.8	ns
t _{PLH}	LOW to HIGH propagation delay	A to B	-	15.8	-	12.5	-	12.3	-	12.1	ns
t _{PHL}	HIGH to LOW propagation delay	B to A	-	15.9	-	13.9	-	13.8	-	15.0	ns
t _{PLH}	LOW to HIGH propagation delay	B to A	-	13.1	-	8.6	-	7.0	-	5.8	ns
t _{en}	enable time	OE to A; B [1]	-	200	-	200	-	200	-	200	ns
t _{dis}	disable time	OE to A; no external load [1]	-	18	-	18	-	18	-	18	ns
		OE to B; no external load [2]	-	19	-	18	-	18	-	18	ns
		OE to A; see Fig. 3	-	120	-	120	-	120	-	125	ns
		OE to B; see Fig. 3	-	170	-	125	-	175	-	125	ns
t _{TLH}	LOW to HIGH output transition time	A port	2.6	16.4	2.8	12.3	2.0	11.3	2.0	10.4	ns
		B port	2.9	16.1	1.9	10.1	0.9	6.6	0.7	3.8	ns
t _{THL}	HIGH to LOW output transition time	A port	2.1	12.4	1.5	9.6	1.2	8.5	0.8	7.5	ns
		B port	1.5	10.9	1.0	6.9	0.9	4.8	0.8	3.9	ns
t _{sk(o)}	output skew time	between channels [3]	-	1.1	-	1.1	-	1.2	-	1.1	ns
t _W	pulse width	data inputs	25	-	25	-	25	-	25	-	ns
f _{data}	data rate		-	40	-	40	-	40	-	40	Mbps
V _{CC(A)} = 1.8 V ± 0.15 V											
t _{PHL}	HIGH to LOW propagation delay	A to B	-	12.1	-	9.1	-	8.1	-	7.4	ns
t _{PLH}	LOW to HIGH propagation delay	A to B	-	14.1	-	10.5	-	9.3	-	8.1	ns
t _{PHL}	HIGH to LOW propagation delay	B to A	-	12.3	-	10.0	-	9.3	-	8.8	ns
t _{PLH}	LOW to HIGH propagation delay	B to A	-	12.8	-	8.8	-	7.3	-	6.3	ns
t _{en}	enable time	OE to A; B [1]	-	200	-	200	-	200	-	200	ns
t _{dis}	disable time	OE to A; no external load [1]	-	14	-	14	-	14	-	14	ns
		OE to B; no external load [2]	-	17	-	14	-	14	-	14	ns
		OE to A; see Fig. 3	-	140	-	140	-	140	-	145	ns
		OE to B; see Fig. 3	-	165	-	125	-	175	-	125	ns
t _{TLH}	LOW to HIGH output transition time	A port	2.2	14.9	2.0	10.8	1.9	9.8	1.9	9.0	ns
		B port	2.8	15.3	1.8	9.6	1.2	6.6	0.7	3.6	ns
t _{THL}	HIGH to LOW output transition time	A port	1.8	11.0	1.3	8.3	0.9	7.1	0.6	6.1	ns
		B port	1.3	10.4	1.0	6.8	0.9	4.9	0.7	3.8	ns
t _{sk(o)}	output skew time	between channels [3]	-	1.1	-	1.1	-	1.1	-	1.1	ns
t _W	pulse width	data inputs	25	-	20	-	20	-	20	-	ns
f _{data}	data rate		-	40	-	50	-	50	-	50	Mbps

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	V _{CC(B)}								Unit	
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V			
			Min	Max	Min	Max	Min	Max	Min	Max		
V _{CC(A)} = 2.5 V ± 0.2 V												
t _{PHL}	HIGH to LOW propagation delay	A to B	-	-	-	7.8	-	6.6	-	5.9	ns	
t _{PLH}	LOW to HIGH propagation delay	A to B	-	-	-	8.5	-	7.4	-	6.5	ns	
t _{PHL}	HIGH to LOW propagation delay	B to A	-	-	-	7.4	-	6.0	-	5.3	ns	
t _{PLH}	LOW to HIGH propagation delay	B to A	-	-	-	7.8	-	5.8	-	4.5	ns	
t _{en}	enable time	OE to A; B [1]	-	-	-	200	-	200	-	200	ns	
t _{dis}	disable time	OE to A; no external load [1]	-	-	-	10	-	10	-	10	ns	
		OE to B; no external load [2]	-	-	-	12	-	10	-	10	ns	
		OE to A; see Fig. 3	-	-	-	105	-	105	-	105	ns	
		OE to B; see Fig. 3	-	-	-	125	-	175	-	120	ns	
t _{TLH}	LOW to HIGH output transition time	A port	-	-	1.7	9.1	1.7	8.0	1.8	7.3	ns	
		B port	-	-	1.8	9.1	1.3	6.8	0.9	4.1	ns	
t _{THL}	HIGH to LOW output transition time	A port	-	-	1.3	7.1	0.8	5.9	0.6	4.8	ns	
		B port	-	-	1.1	6.8	0.9	5.1	0.7	3.8	ns	
t _{sk(o)}	output skew time	between channels [3]	-	-	-	1.1	-	1.3	-	1.1	ns	
t _W	pulse width	data inputs	-	-	16.7	-	12.5	-	12.5	-	ns	
f _{data}	data rate		-	-	-	60	-	80	-	80	Mbps	

Dual supply translating transceiver; open drain; auto direction sensing

Symbol	Parameter	Conditions	V _{CC(B)}								Unit	
			1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V			
			Min	Max	Min	Max	Min	Max	Min	Max		
V _{CC(A)} = 3.3 V ± 0.3 V												
t _{PHL}	HIGH to LOW propagation delay	A to B	-	-	-	-	-	6.1	-	5.3	ns	
t _{PLH}	LOW to HIGH propagation delay	A to B	-	-	-	-	-	6.5	-	5.8	ns	
t _{PHL}	HIGH to LOW propagation delay	B to A	-	-	-	-	-	5.9	-	4.8	ns	
t _{PLH}	LOW to HIGH propagation delay	B to A	-	-	-	-	-	5.9	-	5.4	ns	
t _{en}	enable time	OE to A; B [1]	-	-	-	-	-	200	-	200	ns	
t _{dis}	disable time	OE to A; no external load [1]	-	-	-	-	-	9	-	9	ns	
		OE to B; no external load [2]	-	-	-	-	-	9	-	9	ns	
		OE to A; see Fig. 3	-	-	-	-	-	150	-	150	ns	
		OE to B; see Fig. 3	-	-	-	-	-	170	-	120	ns	
t _{TLH}	LOW to HIGH output transition time	A port	-	-	-	-	1.6	7.1	1.8	6.3	ns	
		B port	-	-	-	-	1.5	6.8	0.9	4.9	ns	
t _{THL}	HIGH to LOW output transition time	A port	-	-	-	-	1.0	5.6	0.7	4.4	ns	
		B port	-	-	-	-	1.0	5.3	0.8	3.9	ns	
t _{sk(o)}	output skew time	between channels [3]	-	-	-	-	-	1.1	-	1.1	ns	
t _W	pulse width	data inputs	-	-	-	-	13	-	10	-	ns	
f _{data}	data rate		-	-	-	-	-	80	-	100	Mbps	

[1] t_{en} is the same as t_{PZL} and t_{PZH}; t_{dis} is the same as t_{PLZ} and t_{PHZ}.
[2] These values are guaranteed by design.
[3] Skew between any two outputs of the same package switching in the same direction.

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Table 12. Typical power dissipation capacitance

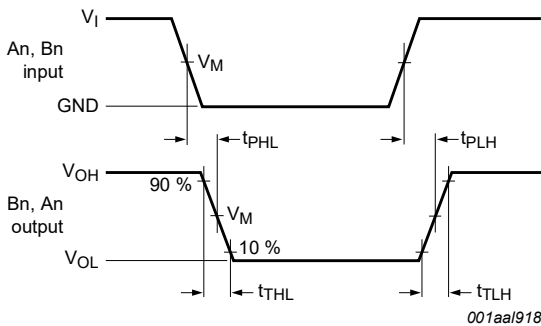
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5 [1] [2]

Symbol	Parameter	Conditions	V _{CC(A)}							Unit
			1.2 V	1.2 V	1.5 V	1.8 V	2.5 V	2.5 V	3.3 V	
			V _{CC(B)}							
			1.8 V	5.0 V	1.8 V	1.8 V	2.5 V	5.0 V	3.3 V to 5.0 V	
T _{amb} = 25 °C										
C _{PD}	power dissipation capacitance	outputs enabled; OE = V _{CC(A)}								
		A port: (direction A to B)	7.7	7.4	8.0	8.3	8.4	8.0	8.7	pF
		A port: (direction B to A)	5.9	6.3	6.6	7.5	8.2	7.0	8.5	pF
		B port: (direction A to B)	20.8	26.6	19.9	19.7	20.0	24.3	22.2	pF
		B port: (direction B to A)	18.9	23.8	18.4	18.4	19.0	21.2	20.3	pF
		outputs disabled; OE = GND								
		A port: (direction A to B)	0.01	0.01	0.01	0.01	0.01	0.01	0.01	pF
		A port: (direction B to A)	0.01	0.01	0.01	0.01	0.01	0.01	0.01	pF
		B port: (direction A to B)	0.01	0.02	0.01	0.01	0.01	0.01	0.01	pF
		B port: (direction B to A)	0.01	0.03	0.01	0.01	0.01	0.01	0.01	pF

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
P_D = C_{PD} × V_{CC}² × f_i × N + Σ(C_L × V_{CC}² × f_o) where:
f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = load capacitance in pF;
V_{CC} = supply voltage in V; N = number of inputs switching; Σ(C_L × V_{CC}² × f_o) = sum of the outputs.

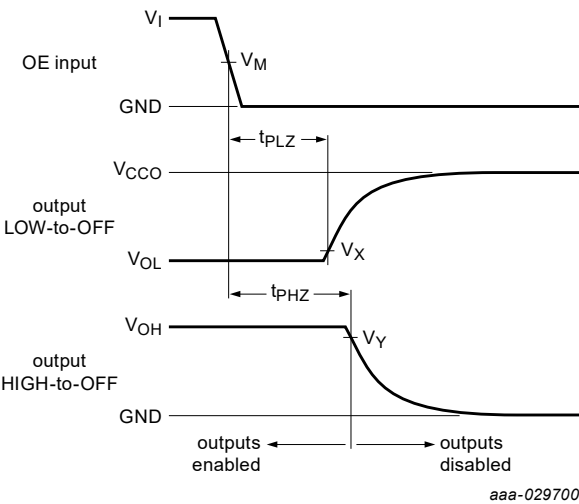
[2] f_i = 10 MHz; V_i = GND to V_{CC}; t_r = t_f = 1 ns; C_L = 0 pF; R_L = ∞ Ω.

11.1. Waveforms and test circuit



Measurement points are given in [Table 13](#).
 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 2. The data input (An, Bn) to data output (Bn, An) propagation delay times



Measurement points are given in [Table 13](#).
 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.
 V_{CCO} is the supply voltage associated with the output.

Fig. 3. Disable times

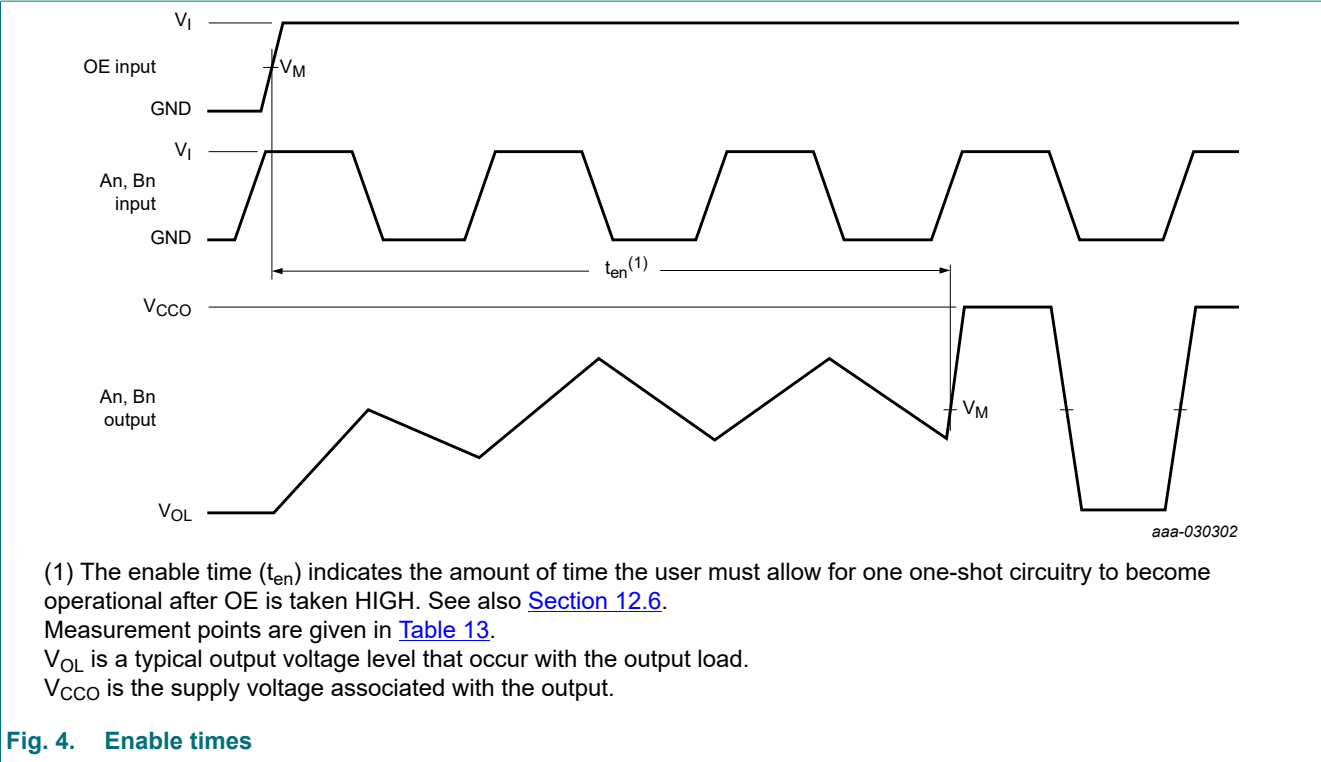


Fig. 4. Enable times

Table 13. Measurement points [1] [2]

Supply voltage	Input	Output		
V_{CCO}	V_M	V_M	V_X	V_Y
1.2 V	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.1\text{ V}$	$V_{OH} - 0.1\text{ V}$
$1.5\text{ V} \pm 0.1\text{ V}$	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.1\text{ V}$	$V_{OH} - 0.1\text{ V}$
$1.8\text{ V} \pm 0.15\text{ V}$	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
$2.5\text{ V} \pm 0.2\text{ V}$	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$
$3.3\text{ V} \pm 0.3\text{ V}$	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$
$5.0\text{ V} \pm 0.5\text{ V}$	$0.5V_{CCI}$	$0.5V_{CCO}$	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$

[1] V_{CCI} is the supply voltage associated with the input.
[2] V_{CCO} is the supply voltage associated with the output.

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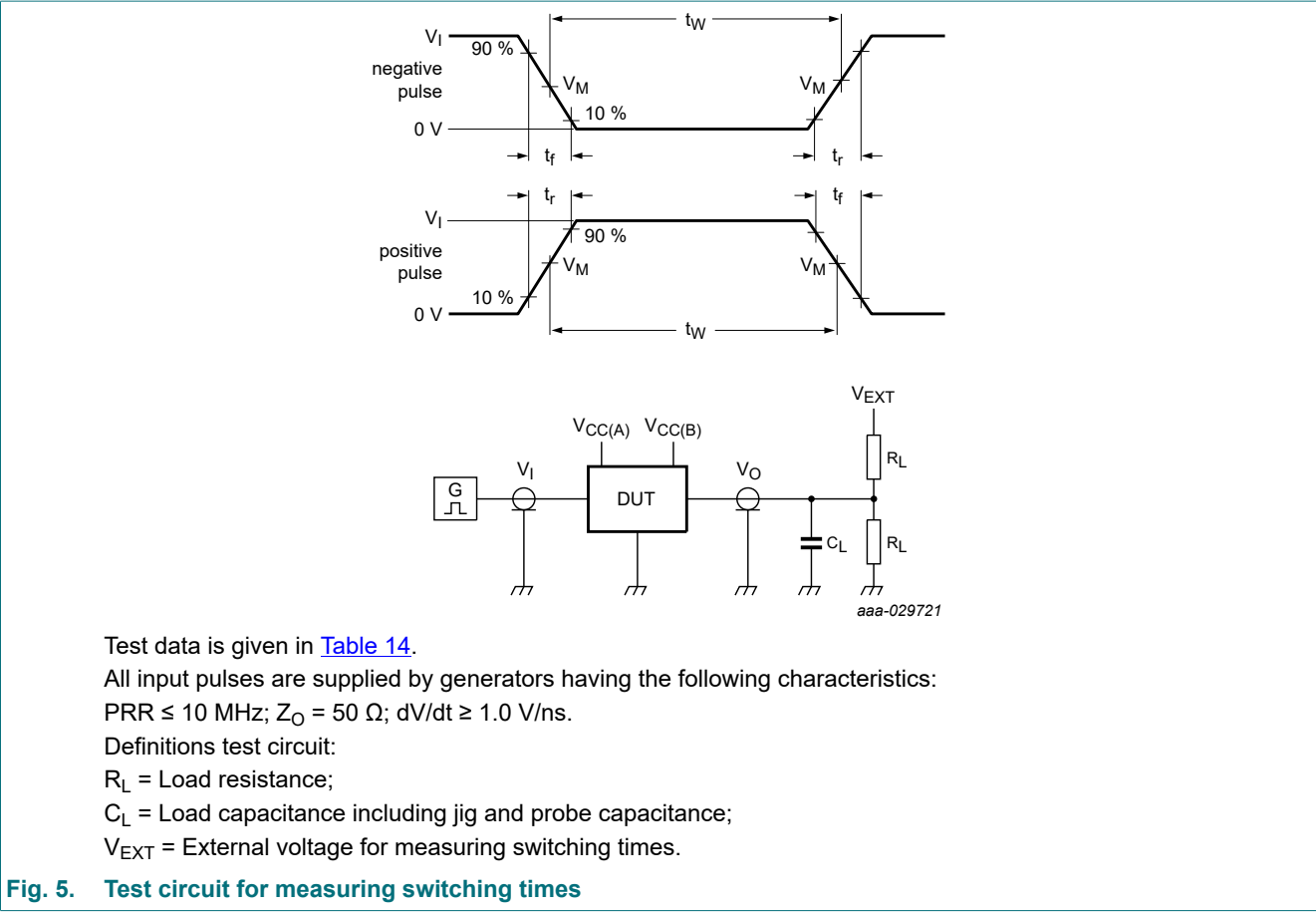


Table 14. Test data

Supply voltage		Input		Load		V _{EXT}		
V _{CC(A)}	V _{CC(B)}	V _I [1]	Δt/ΔV	C _L	R _L [2]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
1.2 V to 3.6 V	1.65 V to 5.5 V	V _{CCI}	≤ 1.0 ns/V	15 pF	50 kΩ, 1 MΩ	open	open	2V _{CCO}

- [1] V_{CCI} is the supply voltage associated with the input.
- [2] For measuring data rate, pulse width, propagation delay and output rise and fall measurements, R_L = 1 MΩ;
for measuring enable and disable times, R_L = 50 kΩ.
- [3] V_{CCO} is the supply voltage associated with the output.

12. Application information

12.1. Voltage level-translation applications

The NXS0108 can be used in point-to-point applications to interface between devices or systems operating at different supply voltages. The device is primarily targeted at I²C or 1-wire which use open-drain drivers, it may also be used in applications where push-pull drivers are connected to the ports, however the NXB0108 may be more suitable.

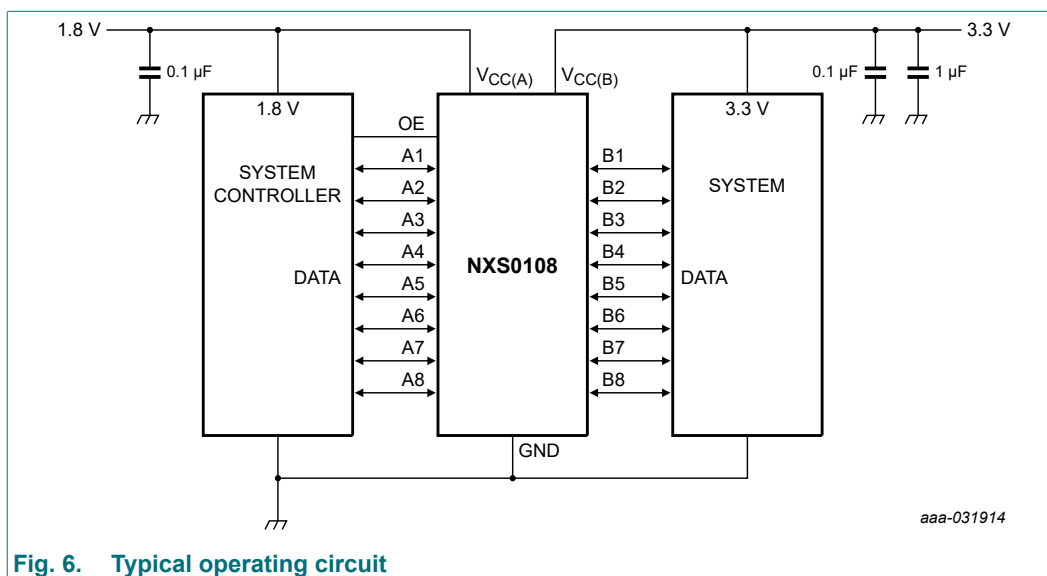


Fig. 6. Typical operating circuit

12.2. Architecture

The architecture of the NXS0108 is shown in Fig. 7. The device does not require an extra input signal to control the direction of data flow from A to B or B to A.

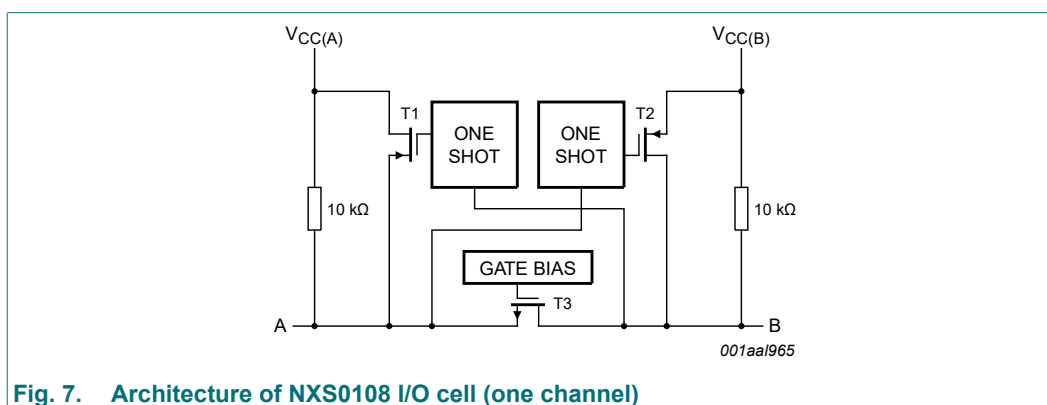


Fig. 7. Architecture of NXS0108 I/O cell (one channel)

The NXS0108 is a "switch" type voltage translator, it employs two key circuits to enable voltage translation:

1. A pass-gate transistor (N-channel) that ties the ports together.
2. An output edge-rate accelerator that detects and accelerates rising edges on the I/O pins.

The gate bias voltage of the pass gate transistor (T3) is set at approximately one threshold voltage above the V_{CC} level of the low-voltage side. During a LOW-to-HIGH transition the output one-shot accelerates the output transition by switching on the PMOS transistors (T1, T2) bypassing the 10 kΩ pull-up resistors and increasing current drive capability. The one-shot is activated once the input transition reaches approximately $V_{CC}/2$; it is de-activated approximately 50 ns after the output

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reaches $V_{CCO}/2$. During the acceleration time the driver output resistance is between approximately 50 Ω and 70 Ω . To avoid signal contention and minimize dynamic I_{CC} , the user should wait for the one-shot circuit to turn-off before applying a signal in the opposite direction. Pull-up resistors are included in the device for DC current sourcing capability.

12.3. Input driver requirements

As the NXS0108 is a switch type translator, properties of the input driver directly effect the output signal. The external open-drain or push-pull driver applied to an I/O determines the static current sinking capability of the system; the max data rate, HIGH-to-LOW output transition time (t_{THL}) and propagation delay (t_{PHL}) are dependent upon the output impedance and edge-rate of the external driver. The limits provided for these parameters in the datasheet assume a driver with output impedance below 50 Ω is used.

12.4. Output load considerations

The maximum lumped capacitive load that can be driven is dependant upon the one-shot pulse duration. In cases with very heavy capacitive loading there is a risk that the output will not reach the positive rail within the one-shot pulse duration. To avoid excessive capacitive loading and to ensure correct triggering of the one-shot it's recommended to use short trace lengths and low capacitance connectors on NXS0108 PCB layouts. To ensure low impedance termination and avoid output signal oscillations and one-shot re-triggering, the length of the PCB trace should be such that the round trip delay of any reflection is within the one-shot pulse duration (approximately 50 ns).

12.5. Power up

During operation $V_{CC(A)}$ must never be higher than $V_{CC(B)}$, however during power-up $V_{CC(A)} \geq V_{CC(B)}$ does not damage the device, so either power supply can be ramped up first. There is no special power-up sequencing required. The NXS0108 includes circuitry that disables all output ports when either $V_{CC(A)}$ or $V_{CC(B)}$ is switched off.

12.6. Enable and disable

An output enable input (OE) is used to disable the device. Setting OE = LOW causes all I/Os to assume the high-impedance OFF-state. The disable time (t_{dis} with no external load) indicates the delay between when OE goes LOW and when outputs actually become disabled. The enable time (t_{en}) indicates the amount of time the user must allow for one one-shot circuitry to become operational after OE is taken HIGH. To ensure the high-impedance OFF-state during power-up or power-down, pin OE should be tied to GND through a pull-down resistor, the minimum value of the resistor is determined by the current-sourcing capability of the driver.

12.7. Pull-up or pull-down resistors on I/O lines

The NXS0108 has the pull-up resistors dynamically change value based on whether a low or a high is being passed through the I/O line. Each A-port I/O has a pull-up resistor (R_{PUA}) to V_{CCA} and each B-port I/O has a pull-up resistor (R_{PUB}) to V_{CCB} . R_{PUA} and R_{PUB} have a value of 40 k Ω when the output is driving LOW. R_{PUA} and R_{PUB} have a value of 4 k Ω when the output is driving HIGH. R_{PUA} and R_{PUB} are disabled when OE = LOW. This feature provides lower static power consumption (when the I/Os are passing a LOW) and supports lower V_{OL} values for the same size pass-gate transistor and helps improve simultaneous switching performance.

13. Package outline

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

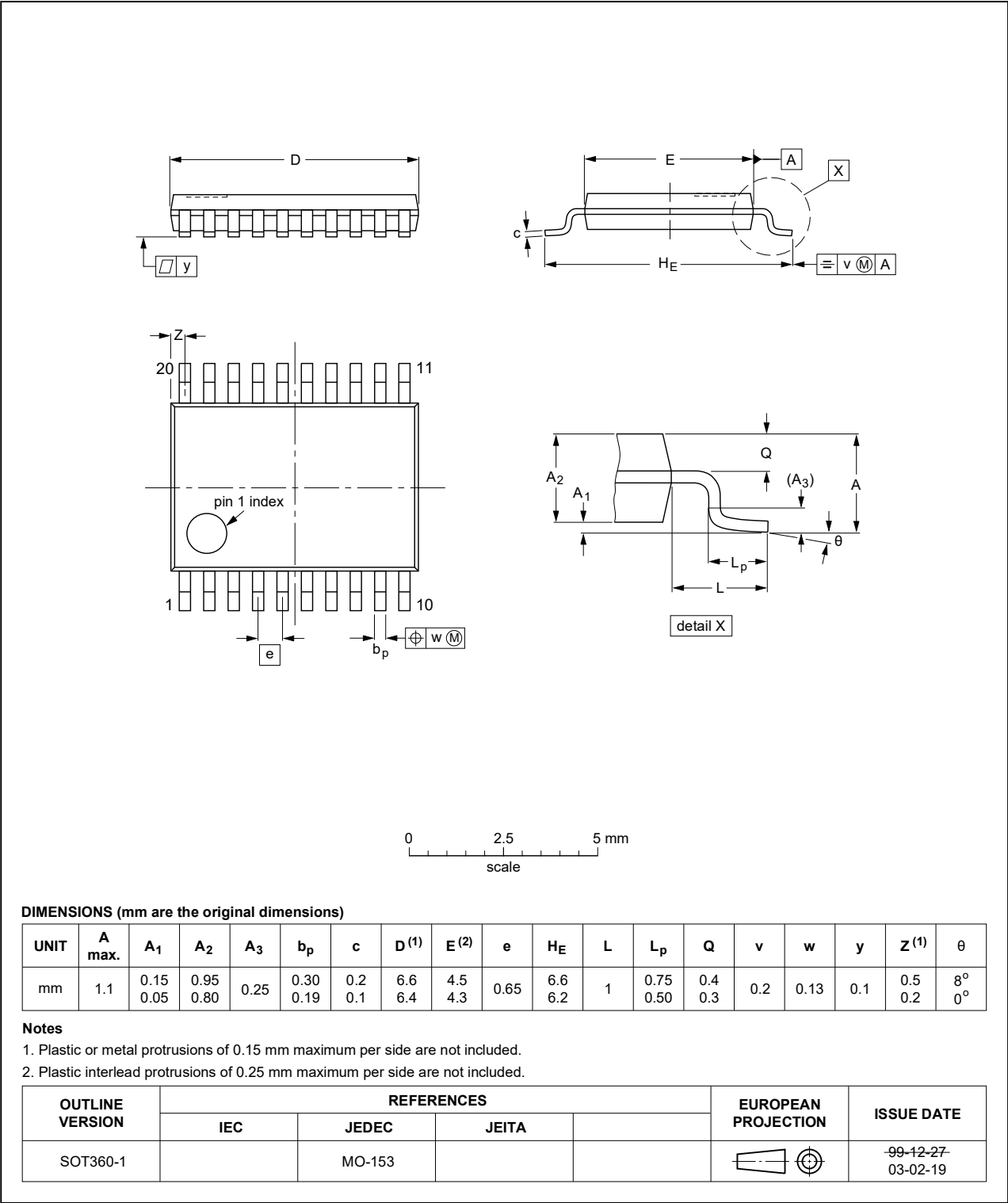


Fig. 8. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;
20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

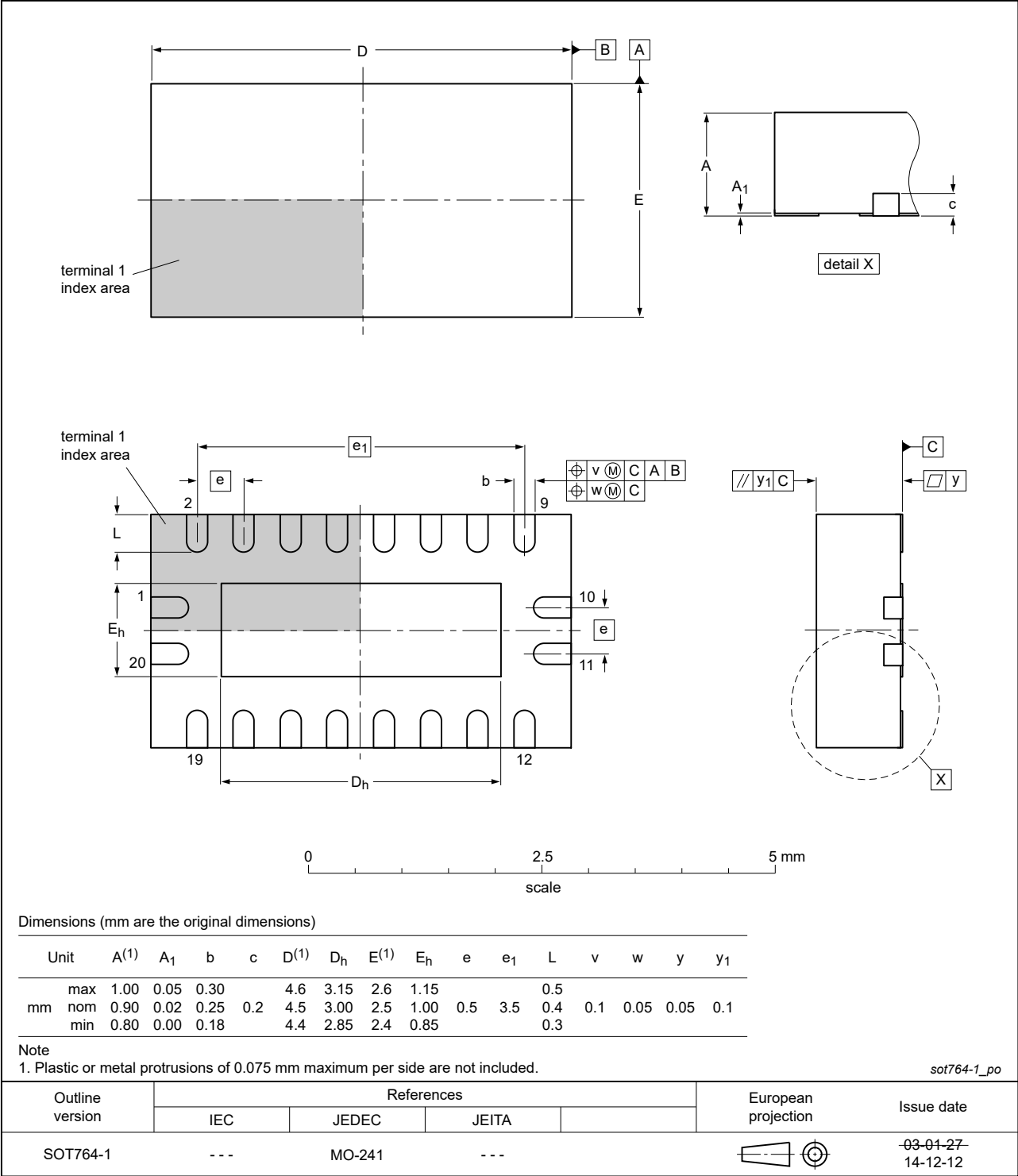


Fig. 9. Package outline SOT764-1 (DHVQFN20)

14. Abbreviations

Table 15. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
I ² C	Inter-Integrated Circuit
JEDEC	Joint Electron Device Engineering Council
SMBus	System Management Bus

15. Revision history

Table 16. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NXS0108 v.1.1	20240731	Product data sheet	-	NXS0108 v.1
NXS0108 v.1	20200915	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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